

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

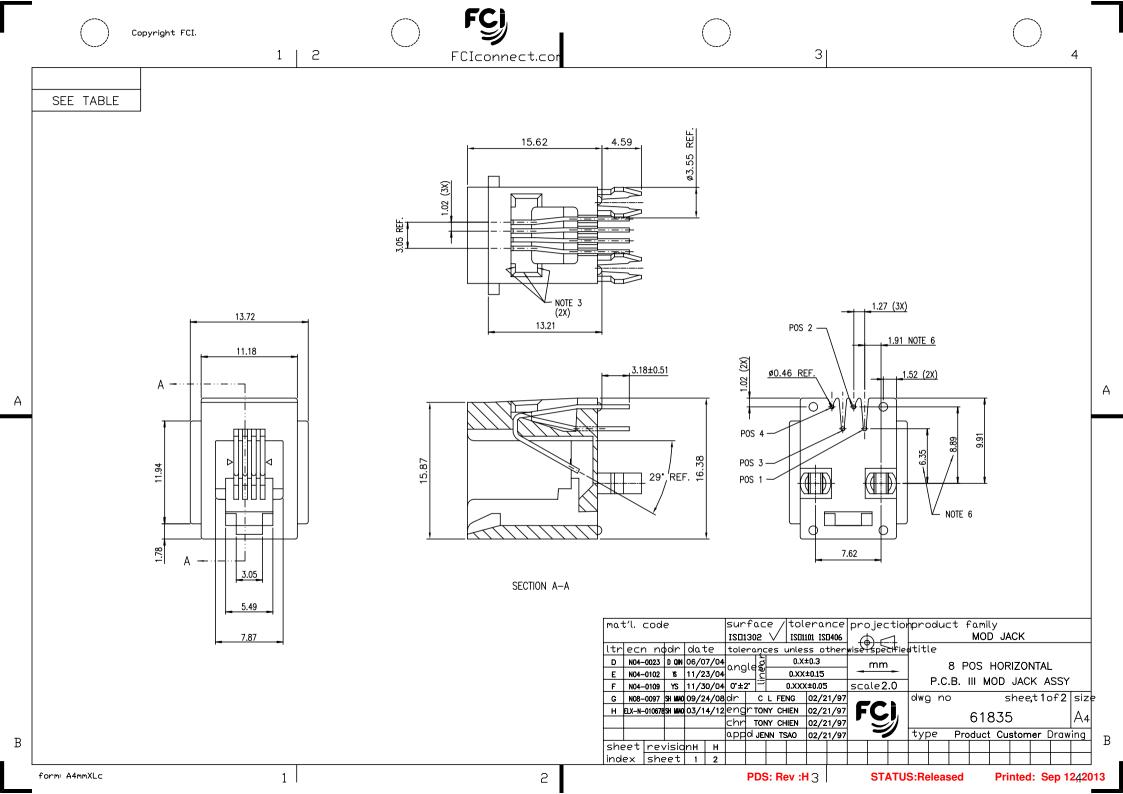
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









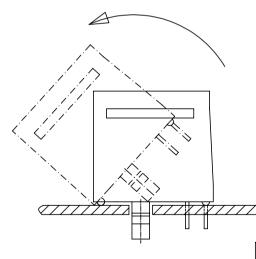
PRODUCT NO.	NO. OF POS	LOADED POS	HSG COLOR			
61835-X441	4	ALL POS	BLACK			
-X421	4	3,4	BLACK			
-X442	4	ALL POS	GRAY			
-X422	4	3,4	GRAY			

PLATING CODE X	PLATING	
0	5u" Au + high performance lubricant]
1	15 u" GOLD]
3	30 u "GOLD	1
4	6 u "GOLD	1
5	50 u "GOLD	

1.91

1.27 TYP

BOARD LAYOUT VIEWED FROM TOP DIRECTION OF DISMOUNT



NOTES:

- P/N WITH DASH X4XX -NORMAL WAVE SOLDERING APPLICATION.
- 2 PACKAGING SPEC. GES-14-351. (USING TRAY).
- 3 SCRATCH MARKS ACCEPTABLE ON THESE SURFACES.
- 4 JACK IS FOR 1.57/.062 THICK PCB.
- 5 SHOULD THE JACK NEED TO BE DISMOUNTED FROM THE PCB. PLS REMOVE JACK AS PER RECOMMENDED METHOD HEREIN. (DETAIL A) NIPPING THE LEGS OF THE PEG TOGETHER IS DISALLOWED, OTHERWISE LEG BREAKAGE MAY OCCUR.
- THESE DIMENSIONS ARE MEASURED FROM THE TOP OF THE PEG.
- 7 THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
- 8 IF LF P/N PACKSGING MEETS GS-14-920 SPECIFICATION
- 9 THE HOUSING WILL WITHSTAND EXPOSURE TO 260° PEAK
 TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION
 WITH A 1.57mm MINIMUM THICK CIRCUIT BOARD
- (10) EQUIVALENT THICKNESS AU AND GXT PLATING HAVE SAME FUNCTION AND THEY ARE ALTERNATIVE BY THE CUSTOEMR.

JACK DISMOUNT METHOD

DETAIL A
NOTE 5

mat	t'l. co	surface / tolerance						projectiohproduct family															
						ISD1302				□406	4	کے	1	MOD JACK									
ltr	ecn	nddr	da	te	tole	raņo	es	unle:	ss o	ther	wise specificatitle												
D	NO4-002	3 D QIN	06/	07/04	angle			0.X±0.3 0.XX±0.15			mm		8 POS HORIZONTAL										
Е	NO4-010	2 YS	11/	23/04							-												
F	NO4-010	9 YS	11/	30/04	0°±2	z =		O.XXX	(±0.05	5	SC0	le2	.0	P.C.B. III MOD JACK ASSY									
G	N08-009	7 SH MIAC	09/	24/08	dr	U	L FE	NG.	02/2	21/97		_	,	dwc	nc)		S	hee	t2c	f2	size	
Н	ELX-N-010	578 SH MIAC	03/	14/12	engriony chien 02/21/ chr iony chien 02/21/			21/97	F	FC) 61835										ا. ۸			
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					app	JENN TSAO			02/2	21/97	/97			type Product Customer Drawing							ing		
she	et r	visio	n																				
inde	index sheet																						

В

form: A4mmXLc

1 |

- ø 3.25±0.08 (2X) i

ø 0.76±0.08 (4X)

2

PDS: Rev :H3

STATUS:Released

Printed: Sep 1242013